#### 15 Watt Isolated DC-DC Converter

SLTS020A

(Revised 1/15/2001)



- Input Voltage Range: 18V to 40V
- 1500 VDC Isolation
- Low Profile
- Current Limit
- Short-Circuit Protection
- Over-Temperature Shutdown
- UL1950 recognized
- CSA 22.2 950 certified
- Meets EN60950

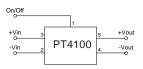
The PT4100—24V series of dc/dc converters provide 18 Watts/in³ of isolated power in a single low-profile module. Designed to operate from a standard 24V telecom bus, these modules employ switching frequencies of up to 850kHz, planar magnetics, and surface-mount construction. They are designed for Telecom, Industrial, Computer, Medical, and other distributed power applications that require input-to-output isolation.

## **Specifications**

Characteristics			PT41			
(T <sub>a</sub> =25°C unless noted)	Symbols	Conditions	Min	Тур	Max	Units
Output Current	$I_{o}$	$\begin{array}{ccc} \text{Over } V_{in} \text{ range,} & V_o = 5V \\ V_o = 12V \\ V_o = 15V \end{array}$	0 0 0	=	3.0 1.25 1.0	A
Current Limit	$I_{cl}$	$\begin{aligned} V_{in} = 18V, & V_o = 5V \\ V_o = 12V \\ V_o = 15V \end{aligned}$	=	4.0 1.75 1.4	=	A
On/Off Standby Current	I <sub>in standby</sub>	$V_{in}$ = 24V, Pin 1 = - $V_{in}$	_	7	10	mA
Short Circuit Current	$I_{sc}$	$\begin{aligned} V_{in} = 24V, & V_o = 5V \\ V_o = 12V \\ V_o = 15V \end{aligned}$	_	6.25 2.5 2.0	_	A
Inrush Current	$I_{\mathrm{ir}} \\ t_{\mathrm{ir}}$	$V_{in}$ = 24V @ max $I_o$ On start-up	_	1.0 1.0	2.0 5.0	A mSec
Input Voltage Range	$V_{in}$	$I_o = 0.1$ to max $I_o$	18.0	24.0	40.0	V
Output Voltage Tolerance	$\Delta V_{o}$	Over V <sub>in</sub> Range T <sub>A</sub> = -40°C to +85°C	_	±1.0	±2.0	$%V_{o}$
Line Regulation	Reg <sub>line</sub>	Over V <sub>in</sub> range @ max I <sub>o</sub>	_	±0.2	±1.0	$%V_{o}$
Load Regulation	Reg <sub>load</sub>	$10\%$ to $100\%$ of $I_o$ max	_	±0.4	±1.0	$%V_{o}$
$V_o$ Ripple/Noise	V <sub>n</sub>	$\begin{array}{l} V_{\rm in} = 24 V,  I_{\rm o} = 3.0 A,  V_{\rm o} = 5 V \\ V_{\rm in} = 24 V,  I_{\rm o} = 1.25 A,   V_{\rm o} = 12 V \\ V_{\rm in} = 24 V,  I_{\rm o} = 1.25 A,   V_{\rm o} = 15 V \end{array}$	_	75 75 100	100 150 200	$\mathrm{mV}_\mathrm{pp}$
Transient Response	t <sub>tr</sub>	50% load change V <sub>o</sub> over/undershoot	_	125 3.0	200 5.0	μSec %V <sub>o</sub>
Efficiency	η	$\begin{array}{l} V_{\rm in} = 24 V, I_o = 3.0 A, V_o = 5 V \\ V_{\rm in} = 24 V, I_o = 1.25 A, V_o = 12 V \\ V_{\rm in} = 24 V, I_o = 1 A, V_o = 15 V \end{array}$	_	82 82 83	_	%
Switching Frequency	$f_{0}$	Over $V_{in}$ and $I_o$ , $V_o$ =5V $V_o$ =12V/15V	800 600	850 650	900 700	kHz
Recommended Operating Temperature Range	$T_a$	V <sub>in</sub> = 24V @ max I <sub>o</sub> Free air convection, (40-60LFM)	-40	_	+85 (1)	°C
Thermal Resistance	$\theta_{\mathrm{ja}}$	Free air convection, (40-60LFM)	_	12	_	°C/W
Case Temperature	$T_c$	@ Thermal shutdown	_	_	100	°C
Storage Temperature	$T_s$		-40	_	110	°C
Mechanical Shock	_	Per Mil-STD-202F, Method 213B, 6mS, Half-sine, mounted to a PCB	_	50	_	G's
Mechanical Vibration	_	Per Mil-STD-202F, Method 204D, 10-500Hz, Soldered in a PCB	_	10	_	G's
Weight	_	_	_	28	_	grams
Isolation Capacitance Resistance			1500 10	 1100 	=	V pF MΩ
Flammability	_	Materials meet UL 94V-0				
Remote On/Off	On (2) Off	Referenced to -V <sub>in</sub>	2.5 0		7.0 0.8	V

## **Notes:** (1) See thermal derating curves.

# **Standard Application**



# **Pin-Out Information**

Pin	Function
1	Remote ON/OFF
2	$-V_{in}$
3	$+V_{in}$
4	$-V_{ m out}$
5	$+V_{out}$
6	Do not connect

## **Ordering Information**

Through-Hole

**PT4104A** = 5 Volts **PT4105A** = 12 Volts **PT4106A** = 15 Volts

Surface Mount

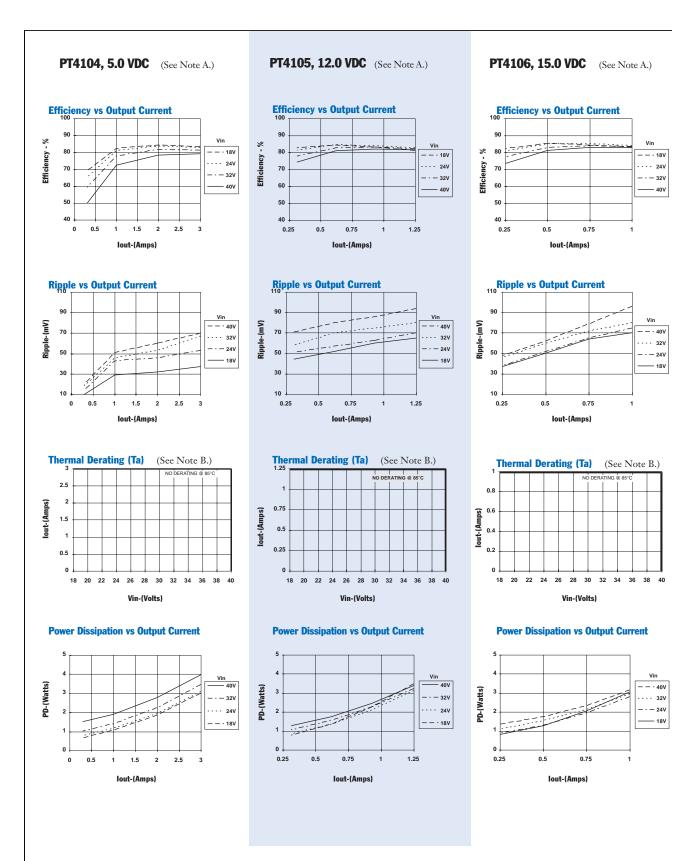
PT4104C = 5 Volts PT4105C = 12 Volts PT4106C = 15 Volts

(For dimensions and PC board layout, see Package Style 710.)



<sup>(2)</sup> If pin2 is left open, the converter will operate when input power is applied.

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Note A: All data listed in the above graphs, except for derating data, has been developed from actual products tested at 25°C. This data is considered typical data for the DC-DC Converter.

Note B: Thermal derating graphs are developed in free air convection cooling of 40-60 LFM.







28-Aug-2008

## **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
PT4104A	NRND	DIP MOD ULE	EGD	6	16	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT4104C	NRND	DIP MOD ULE	EGE	6	16	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT4104CT	NRND	DIP MOD ULE	EGE	6	100	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT4105A	NRND	DIP MOD ULE	EGD	6	16	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT4106A	NRND	DIP MOD ULE	EGD	6	16	Pb-Free (RoHS)	Call TI	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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